

Electrical Specifications

19.16 Multiplexed Expansion Bus Timing

NOTE: Use of the multiplexed expansion bus at 8 MHz is discouraged due to TAD delay factors.

Num	Characteristic ^{(1), (2), (3), (4), (5)}	Delay	Symbol	8 MHz		2 MHz		Unit
				Min	Max	Min	Max	
—	Frequency of operation (E-clock frequency)	—	f_o	dc	8.0	dc	8.0	MHz
1	Cycle time $t_{cyc} = 1/f_o$	—	t_{cyc}	125	—	500	—	ns
2	Pulse width, E low $PW_{EL} = t_{cyc}/2 + \text{delay}$	-4	PW_{EL}	59	—	246	—	ns
3	Pulse width, E high ⁽⁶⁾ $PW_{EH} = t_{cyc}/2 + \text{delay}$	-2	PW_{EH}	59	—	248	—	ns
5	Address delay time $t_{AD} = t_{cyc}/4 + \text{delay}$	27	t_{AD}	—	65.2	—	152	ns
7	Address valid time to ECLK rise $t_{AV} = PW_{EL} - t_{AD}$	—	t_{AV}	-6.2	—	94	—	ns
8	Multiplexed address hold time $t_{MAH} = t_{cyc}/4 + \text{delay}$	-18	t_{MAH}	13	—	107	—	ns
9	Address hold to data valid	—	t_{AHDS}	30	—	20	—	ns
10	Data hold to high impedance $t_{DHz} = t_{AD} - 20$	—	t_{DHz}	—	45.2	—	132	ns
11	Read data setup time	—	t_{DSR}	31.2	—	25	—	ns
12	Read data hold time	—	t_{DHR}	0	—	0	—	ns
13	Write data delay time	—	t_{DDW}	—	53.2	—	165	ns
14	Write data hold time	—	t_{DHW}	25	—	20	—	ns
15	Write data setup time ⁽⁶⁾ $t_{DSW} = PW_{EH} - t_{DDW}$	—	t_{DSW}	5.8	—	83	—	ns
16	Read/write delay time $t_{RWD} = t_{cyc}/4 + \text{delay}$	18	t_{RWD}	—	55.2	—	143	ns
17	Read/write valid time to E rise $t_{RWV} = PW_{EL} - t_{RWD}$	—	t_{RWV}	3.8	—	103	—	ns
18	Read/write hold time	—	t_{RWH}	25	—	20	—	ns
19	Low strobe ⁽⁷⁾ delay time $t_{LSD} = t_{cyc}/4 + \text{delay}$	18	t_{LSD}	—	55.2	—	143	ns
20	Low strobe ⁽⁷⁾ valid time to E rise $t_{LSV} = PW_{EL} - t_{LSD}$	—	t_{LSV}	3.8	—	103	—	ns
21	Low strobe ⁽⁷⁾ hold time	—	t_{LSH}	25	—	20	—	ns
22	Address access time ⁽⁶⁾ $t_{ACCA} = t_{cyc} - t_{AD} - t_{DSR}$	—	t_{ACCA}	—	27.6	—	323	ns
23	Access time from E rise ⁽⁶⁾ $t_{ACCE} = PW_{EH} - t_{DSR}$	—	t_{ACCE}	—	27.8	—	223	ns
24	\overline{DBE} delay from ECLK rise ⁽⁶⁾ $t_{DBED} = t_{cyc}/4 + \text{delay}$	8	t_{DBED}	—	47.2	—	133	ns
25	\overline{DBE} valid time $t_{DBE} = PW_{EH} - t_{DBED}$	—	t_{DBE}	11.8	—	115	—	ns
26	\overline{DBE} hold time from ECLK fall	—	t_{DBEH}	-3	10	-3	10	ns

1. $V_{DD} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L$ to T_H , unless otherwise noted

2. All timings are calculated for normal port drives.

3. Crystal input is required to be within 45% to 55% duty.

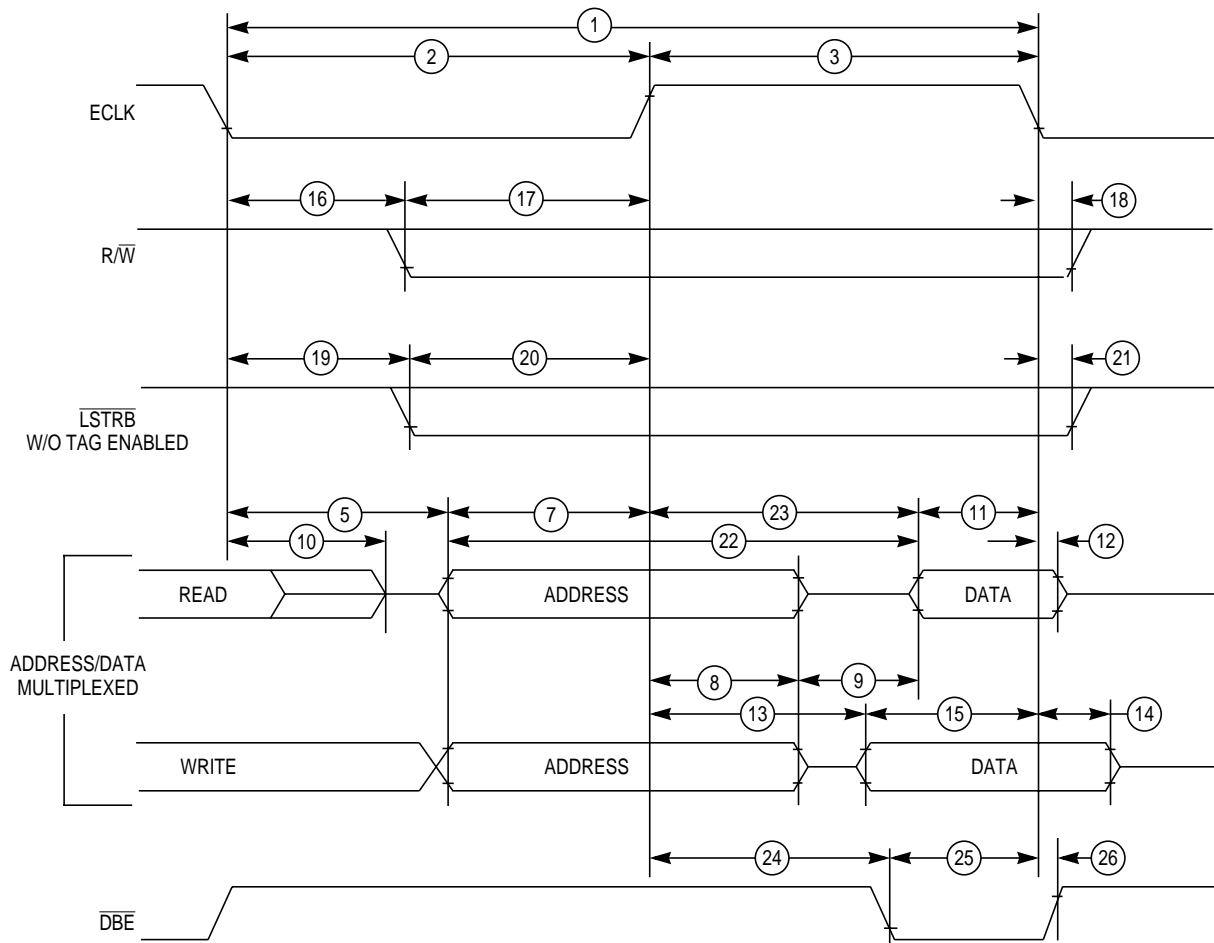
4. Reduced drive must be off to meet these timings.

5. Unequalled loading of pins will affect relative timing numbers.

6. This characteristic is affected by clock stretch.

Add $N \times t_{cyc}$ where $N = 0, 1, 2, \text{ or } 3$, depending on the number of clock stretches.

7. Without TAG enabled



Note: Measurement points shown are 20% and 70% of V_{DD} .

Figure 19-10. Multiplexed Expansion Bus Timing Diagram